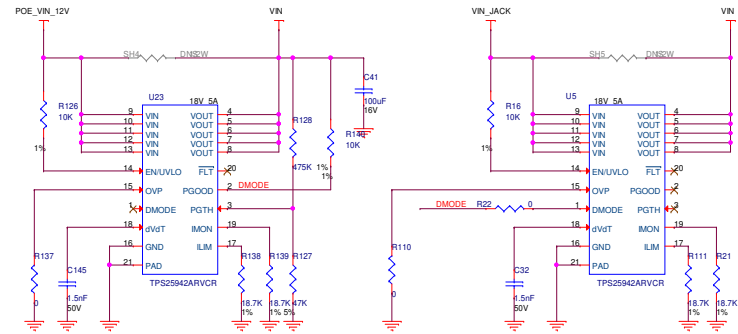
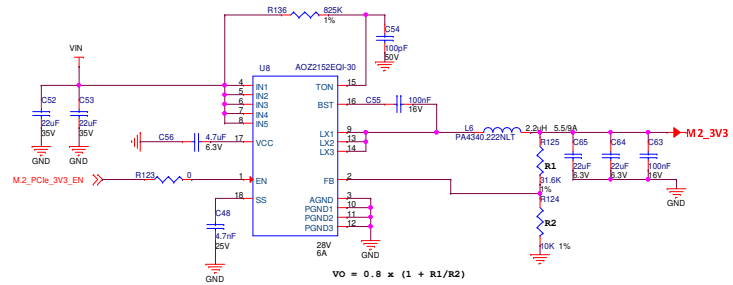


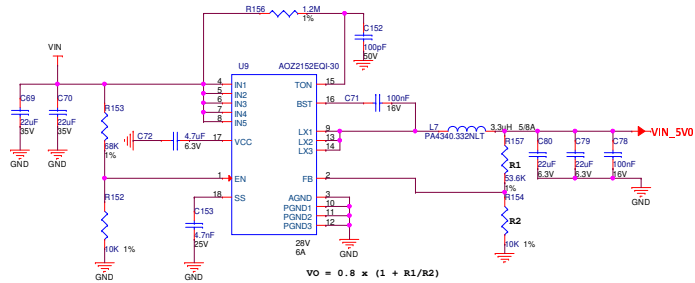
SH4, SH5 bypass U40 and U41 when Vin is a single source (Adapter or POE)



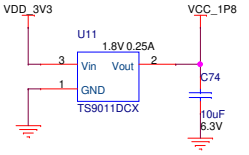
3V3/6A powers the M.2 and Mini-PCIe modules



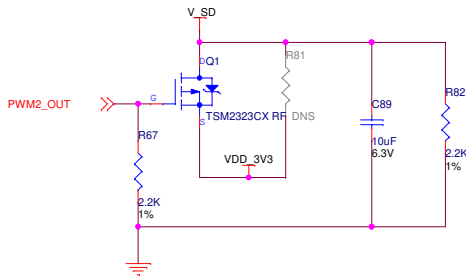
5V/6A powers the SOM and USB power out



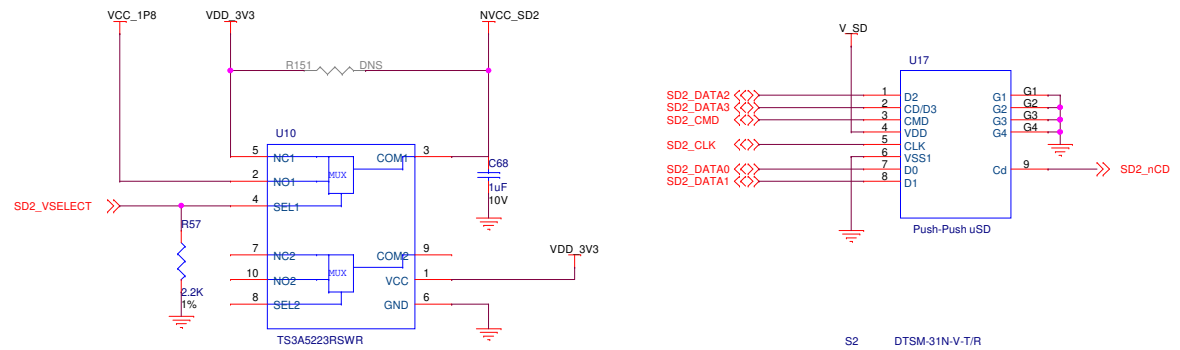
SDIO 3.3v / 1.8v switch circuitry



micro SD power on/off

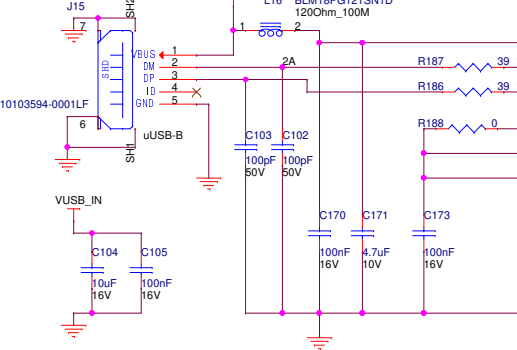


Micro SD connectors (assembly option of push-push type and hinged type)

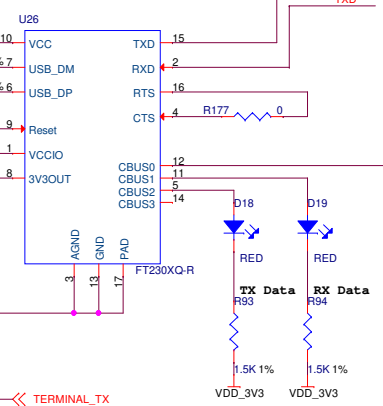


DEBUG/Control PORT

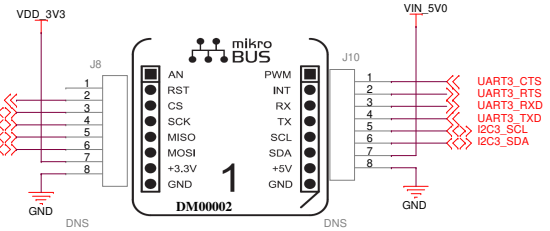
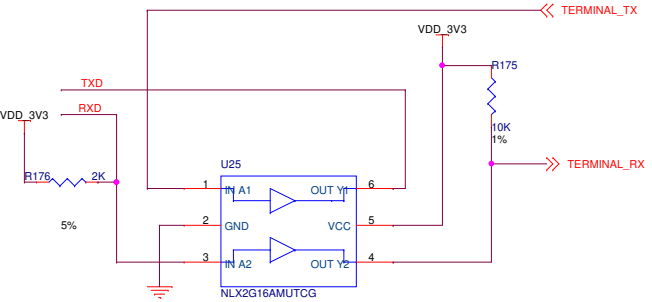
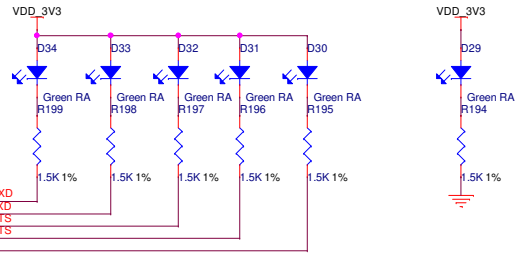
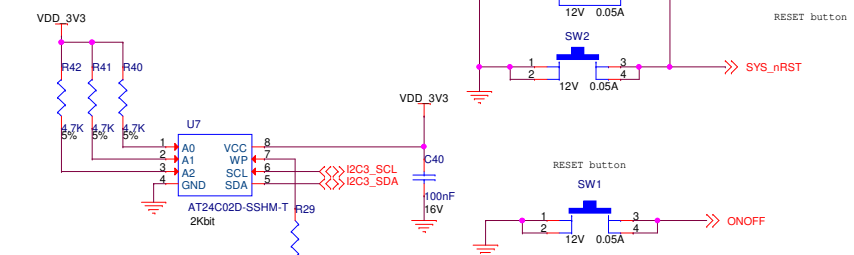
Micro USB Type A/B

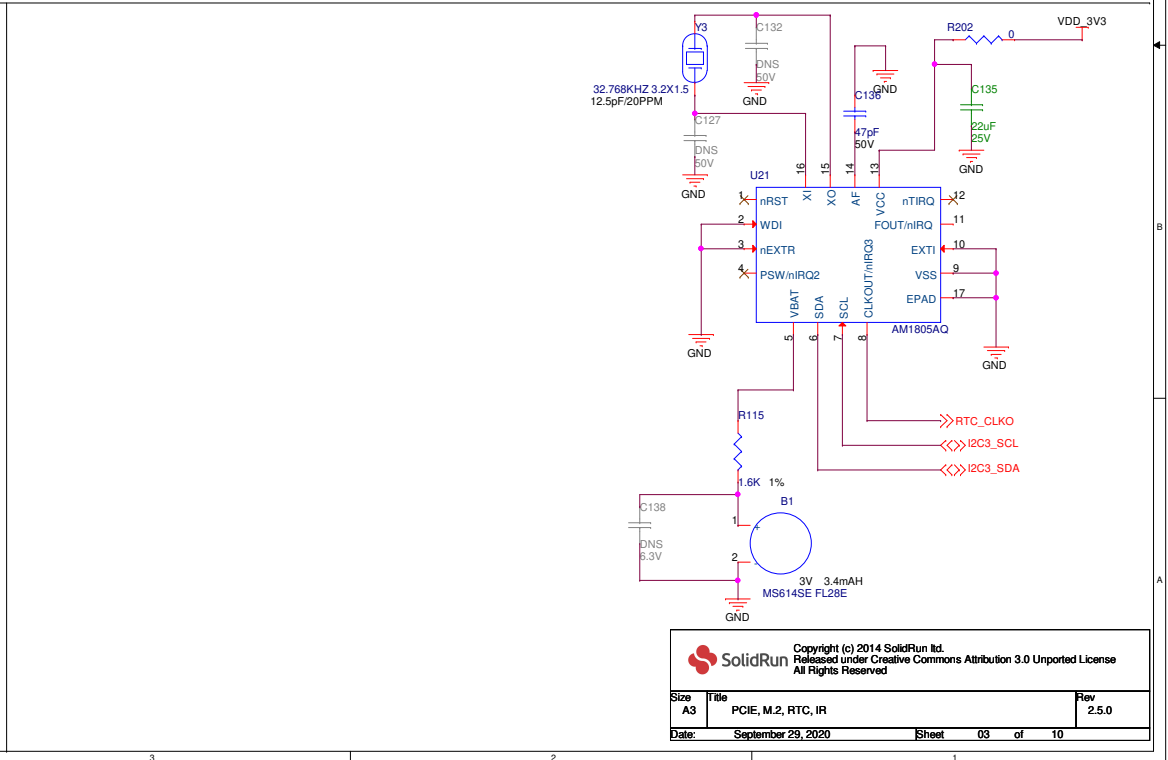
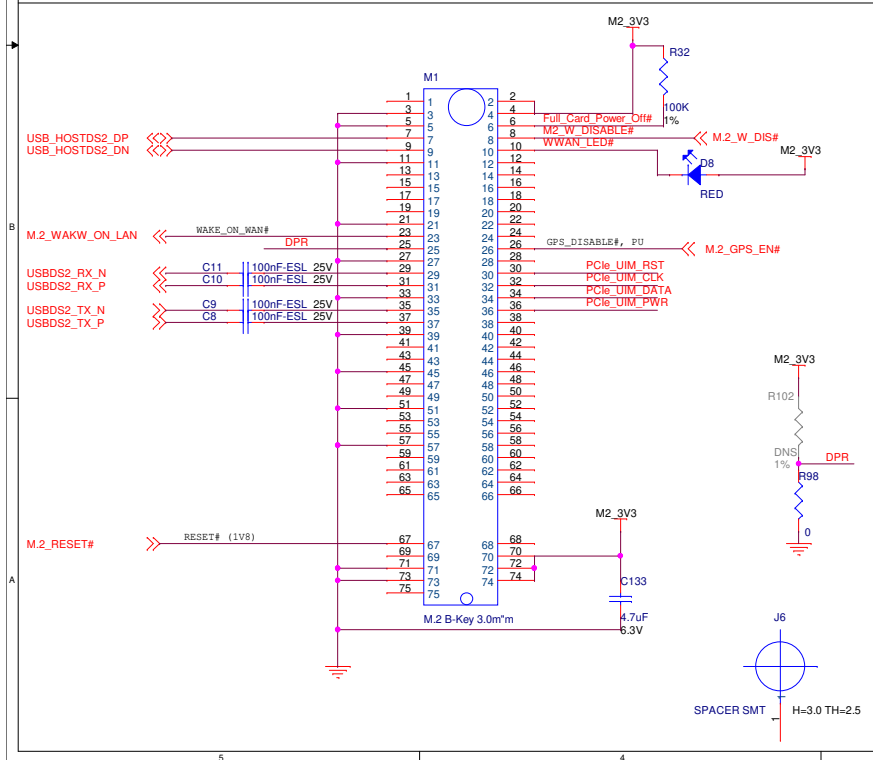
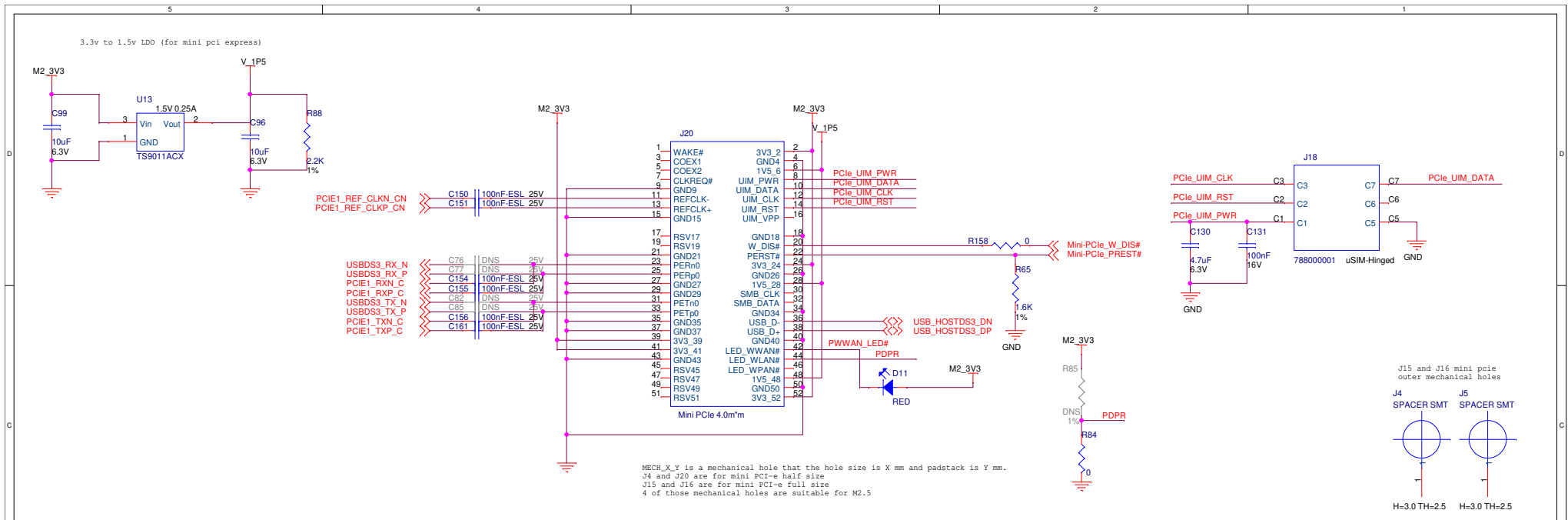


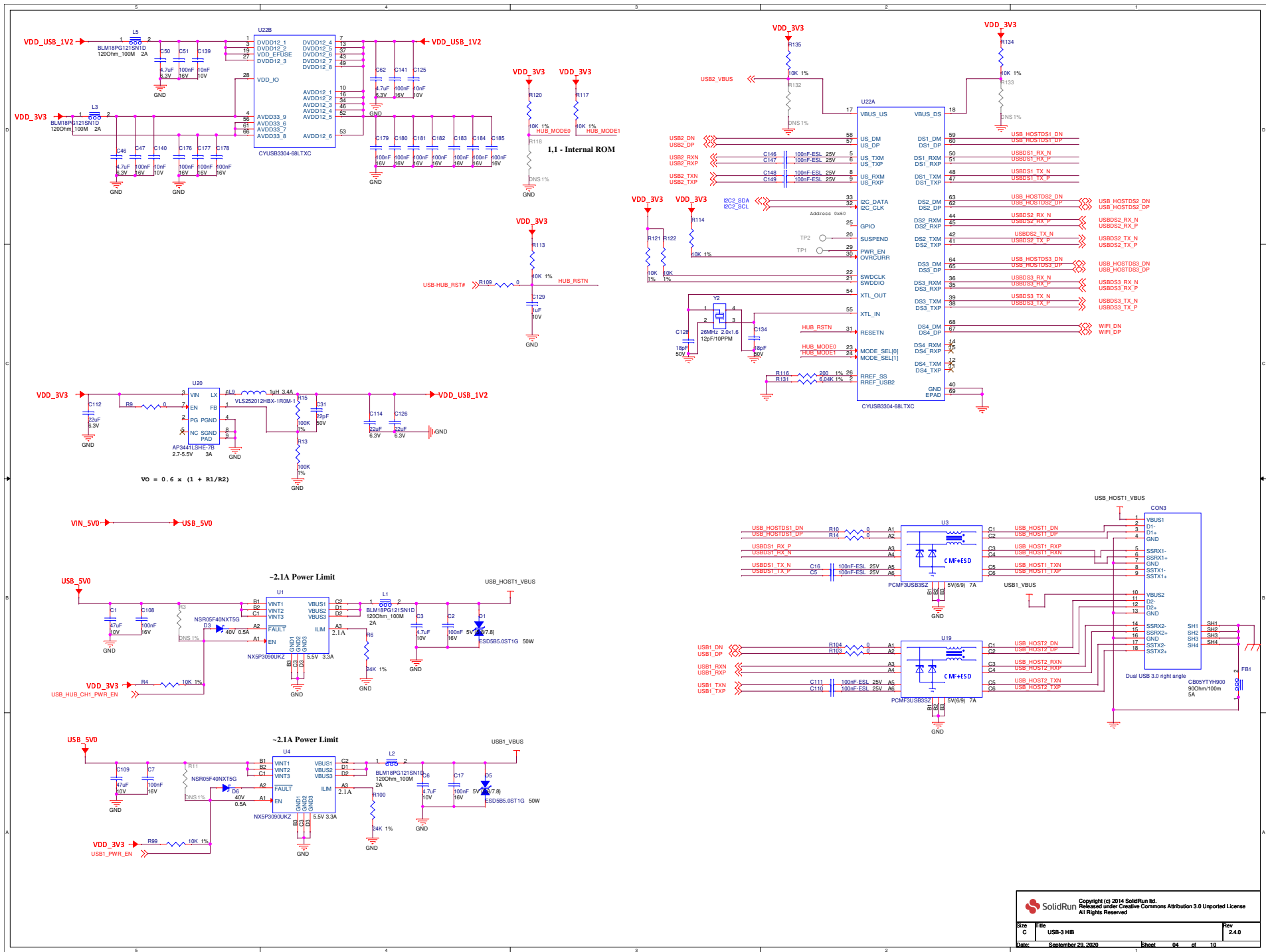
USB to RS-232

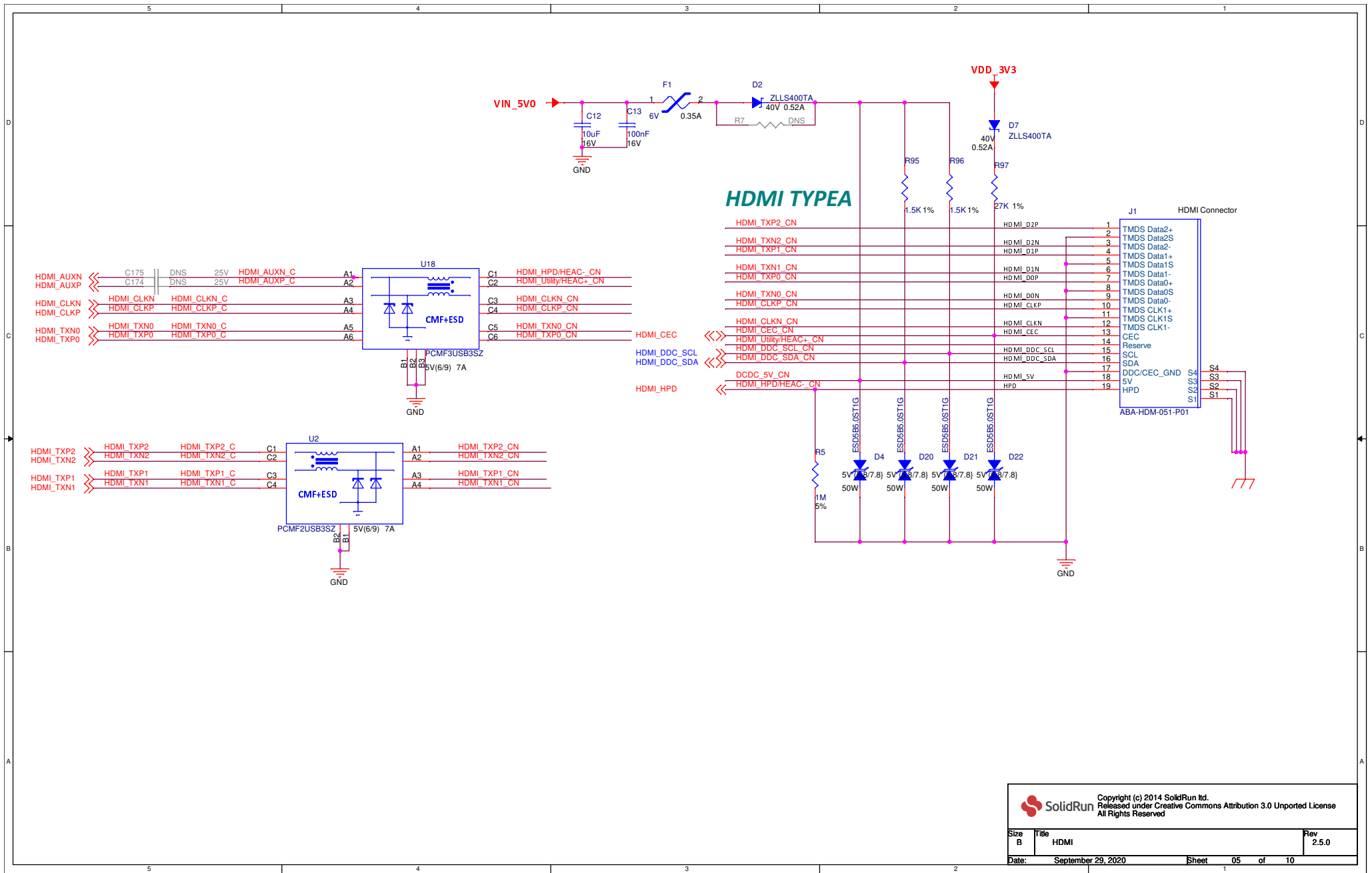


RESET button

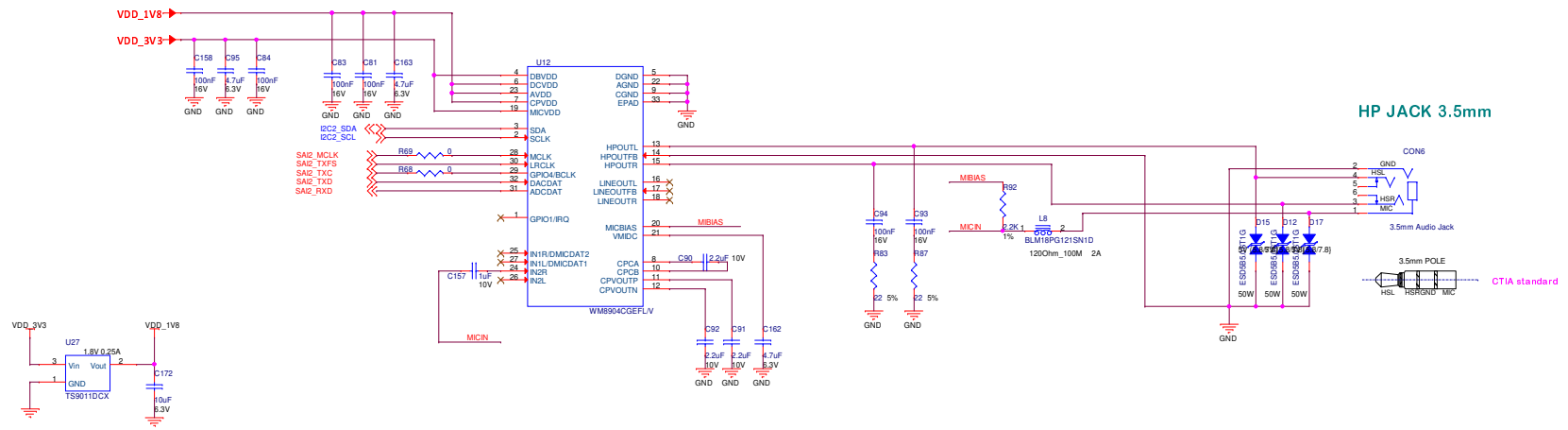


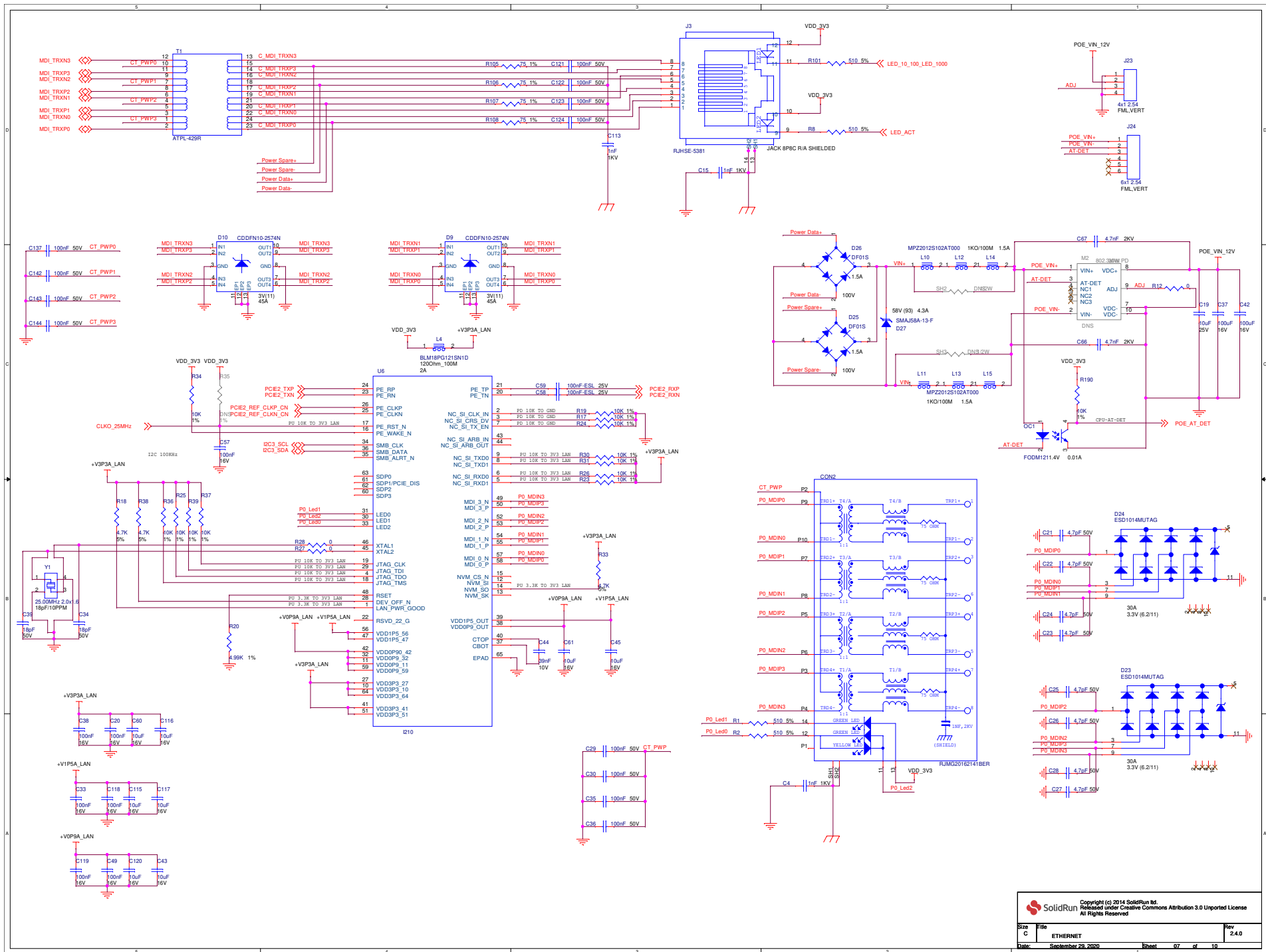


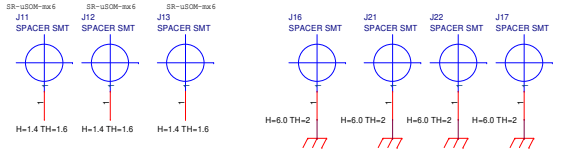
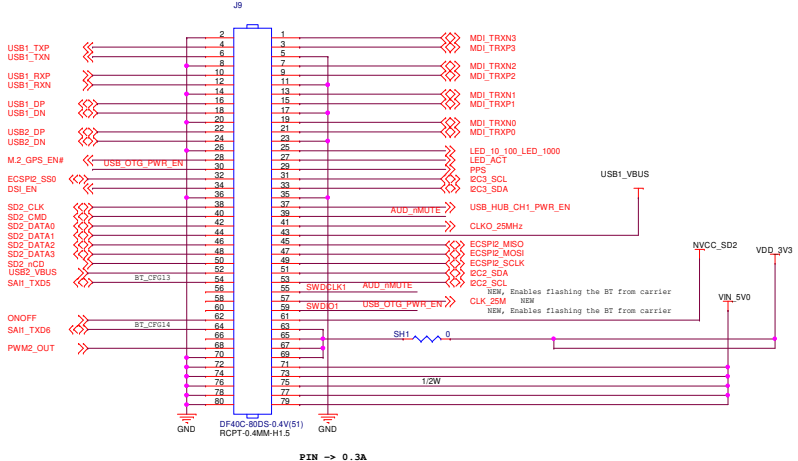
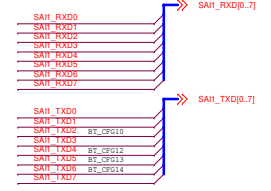
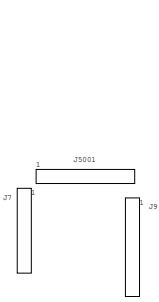
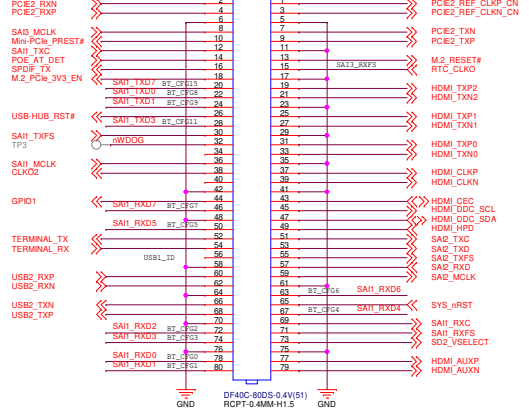
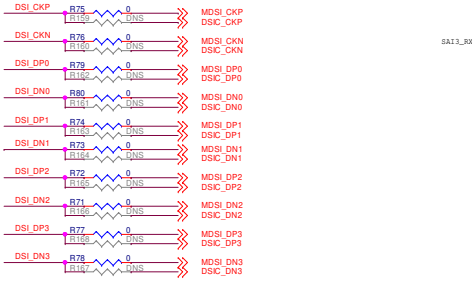




Audio DAC

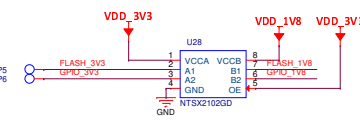
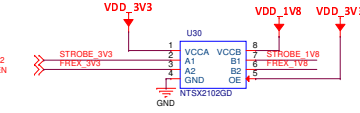
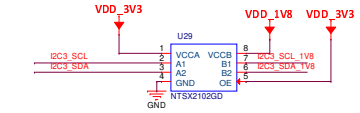
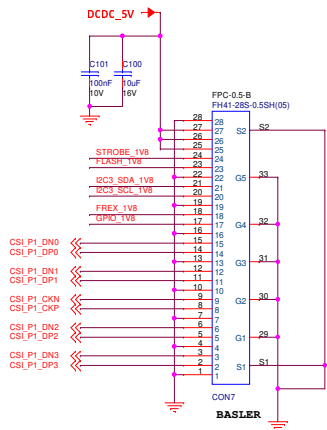
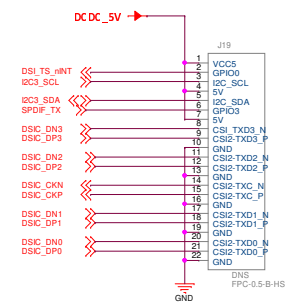
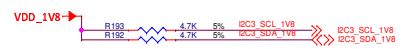
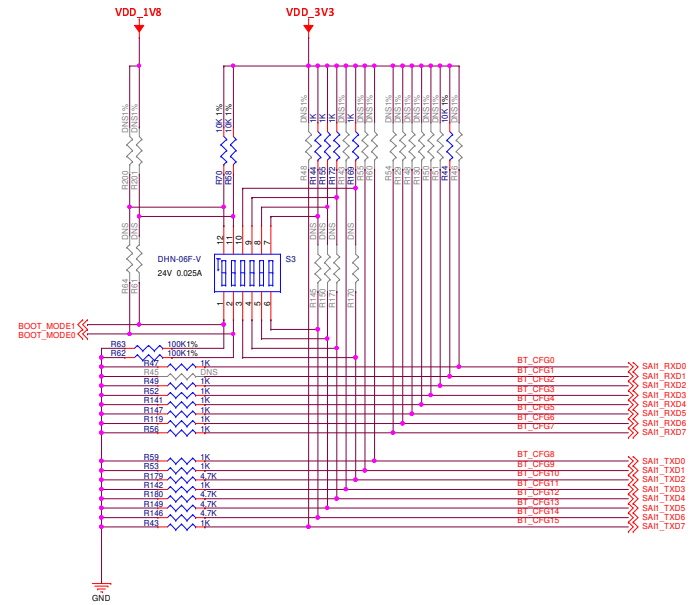
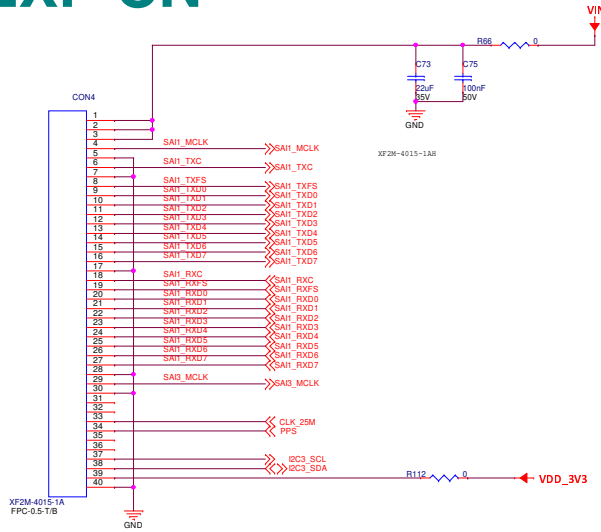


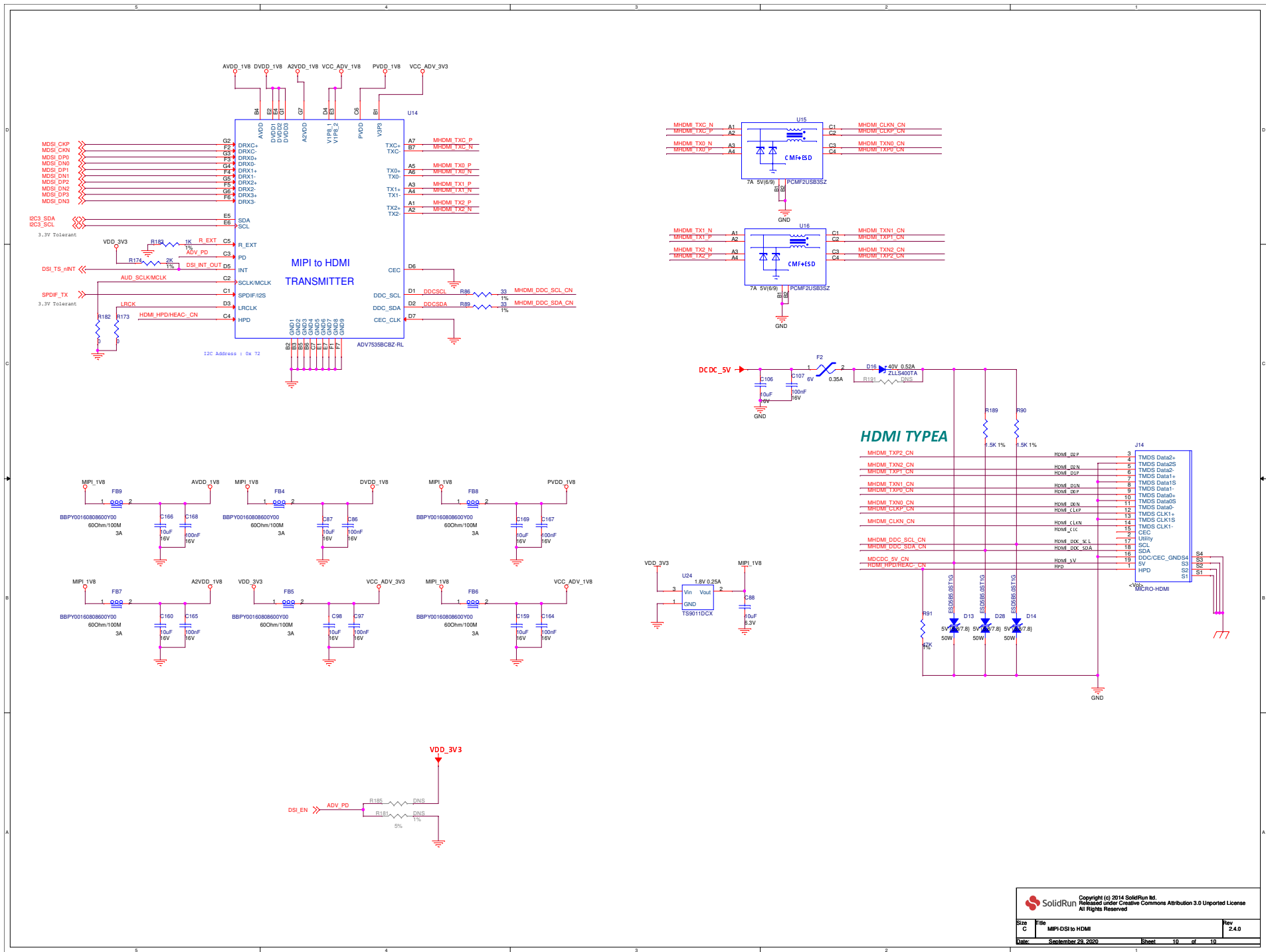





MECH_X_Y is a mechanical hole that the hole size is X mm and padsize is Y mm.
 J19, J16 and J17 are M1.5
 J18, J19 and J27 are M1.8
 J27 is a new mechanical hole for MicroSOM rev 1.4 and newer

EXP CN





| | |
|-------------------|---|
| Rev. 1.0 | Prototype Version |
| Rev. 2.0 | <ol style="list-style-type: none"> 1. Change R257 from 0 Ohm to 100K 2. Adding C297 a 4.7uF on USB Debug 3. Change J35 Routing 4. R23 is assembled instead of R25 to support standalone USB HUB mode 5. Connecting VIN_5V0 to DCDC_5V 6. Changing the Power load switch to TPS25942A to support reverse power blocking 7. Changing J5001, J7 and J9 routing to support the new IMX-8 SOM 8. Change the Audio CODEC to WM8904 to support IN/OUT 9. Change Y4 from 27MHz to 25MHz |
| Rev. 2.1 | <ol style="list-style-type: none"> 1. Adding R373 and R374 0 Ohm to pull OVP input down for U40 and U41. <p>Taking U37 and U38 out of the BOM and change revision to 2.1.3</p> |
| Rev. 2.2 | New features product |
| Rev. 2.3 | <ol style="list-style-type: none"> 1. Fixing I2C routing on U14 2. Fixing symbols errors on layout - U8, U9 and CON7 3. Changing OC1 position to enable POE module assembly on print side |
| Rev. 2.3.1 | <ol style="list-style-type: none"> 1. R185 is not assembled |
| Rev. 2.3.2 | <ol style="list-style-type: none"> 1. On HBP ripple adding U27 and C172 to the assembly list to enable VDD_1V8 |
| Rev. 2.4 | <ol style="list-style-type: none"> 1. Adding R200 and R201 to enable 1.8V pullup on MODE0 and MODE1 signals (IMX8M-Mini and IMX8M-Plus) 2. Connecting a reset signal to the Intel NIC. (CLKO_25MHz, J9-41) 3. Changed the B-t-B connector names to J5001, J7 and J9 according to the SOM. 4. Changed J9 to J10 to support item 3. |
| Rev. 2.5 | <ol style="list-style-type: none"> 1. Changed C135 to 100uF in 1210 package 2. Added R202 (1K OHM) between V3V and the RTC power to support slower slew rate on power down. 3. Added C174 and C175 to support IMX8-Plus HDMI 4. Added C176, C177 and C178 to filter USB HUB AVDD power 5. Added C179 - C185 to filter the HUB VDD_USB_1V2 power 6. Placing U18 on CS and changing some of the signals routing to support that 7. Fixing the reset signal to the Intel NIC. (CLKO_25MHz, J9-41) and R35 is not assembled to set reset to "0". |

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|---|--|---|------------------|
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| | | Size B | Title HISTORY |
| Date: September 25, 2020 | | Sheet 11 of 11 | |